

# **SPECIFICATION**

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SPEC. NO.: PS-5	1085-XXXXX-XXX	<b>REVISION:</b>	Α
PRODUCT NAME	: 0.4mm BTB CONN.	SMT TYPE	
PRODUCT NO:	51085 51086		

PREPARED:	CHECKED:	APPROVED:
JINTAO	BRAVE	BRAVE
DATE: <b>2019/08/08</b>	DATE: <b>2019/08/08</b>	DATE: <b>2019/08/08</b>

ACC.	ectors			Aces P/N:	51085\51086 series	
TITLE:	0.4M	M BOARD TO	BOARD CONN	. SMT TYPE		
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Revision History  Rev.   ECN # Revision Description Prepared Date	Revision History  Rev. ECN # Revision Description Prepared Date	Revision History  Rev. ECN # Revision Description Prepared Date	Revision History  Rev. ECN # Revision Description Prepared Date	Revision History  Rev. ECN # Revision Description	Prepared Date
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#### 2 SCOPE

This specification covers performance, tests and quality requirements for 0.4 mm pitch board to board connectors SMT TYPE

#### 3 APPLICABLE DOCUMENTS

EIA-364: ELECTRONICS INDUSTRIES ASSOCIATION

### 4 REQUIREMENTS

- 4.1 Design and Construction
  - 4.1.1 Product shall be of design, construction and physical dimensions specified on applicable product drawing.
  - 4.1.2 All materials conform to R.o.H.S. and the standard depends on TQ-WI-140101.
- 4.2 Materials and Finish
  - 4.2.1 Contact: High performance copper alloy (Phosphor Bronze)

Finish: (a) Contact Area: Refer to the drawing.

- (b) Under plate: Refer to the drawing.
- (c) Solder area: Refer to the drawing.
- 4.2.2 Housing: Thermoplastic or Thermoplastic High Temp., UL94V-0

#### 4.3 Ratings

- 4.3.1 Working Voltage Less than 36 Volts
- 4.3.2 Voltage: 30 Volts AC/DC
- 4.3.3 Current: 0.5 Amperes (per pin)
- 4.3.4 Operating Temperature :  $-40^{\circ}$ C to  $+85^{\circ}$ C



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### 5 Performance

5.1. Test Requirements and Procedures Summary

Item	Requirement	Standard			
	Product shall meet requirements of	Visual, dimensional and functional			
Examination of Product	applicable product drawing and	per applicable quality inspection			
	specification.	plan.			
	ELECTRICAL				
Item	Requirement	Standard			
Low Level Contact Resistance	40 m Ω Max.(initial)per contact 60 m Ω Max.(finish)	Mate connectors, measure by dry circuit, 20mV Max., 100mA Max. (EIA-364-23)			
Insulation Resistance	100 M Ω Min.	Unmated connectors, apply 100 V DC between adjacent terminals. (EIA-364-21)			
Dielectric Withstanding Voltage	No discharge, flashover or breakdown. Current leakage: 1 mA max.	200 VAC Min. at sea level for 1 minute. Test between adjacent contacts of unmated connectors. (EIA-364-20)			
Temperature rise	30℃ Max. Change allowed	Mate connector: measure the temperature rise at rated current until temperature stable. The ambient condition is still air at 25°C (EIA-364-70,METHOD1,CONDITION1)			
	MECHANICAL				
Item	Requirement	Standard			
Durability	30 cycles.	The sample should be mounted in the tester and fully mated and unmated the number of cycles specified at the rate of 25.4 ± 3mm/min.  (EIA-364-09)			
Mating/Unmating Forces	Mating 0.70N (Max.) /Per Pin Unmating 0.05N(Min.)/Per Pin	Operation Speed: 25.4 ± 3 mm/minute Measure the force required to mate/unmate connector. (EIA-364-13)			
Terminal / Housing Retention Force (Rcpt. CONN.)	0.2N MIN.	Apply axial pull out force at the speed rate of 25.4 ± 3 mm/minute. On the terminal assembled in the housing.			



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	MECHANICA	AL
Item	Requirement	Standard
Vibration	1 μs Max.	The electrical load condition shall be 100 mA maximum for all contacts. Subject to a simple harmonic motion having amplitude of 0.76mm (1.52mm maximum total excursion) in frequency between the limits of 10 and 55 Hz. The entire frequency range, from 10 to 55 Hz and return to 10 Hz, shall be traversed in approximately 1 minute. This motion shall be applied for 2 hours in each of three mutually perpendicular directions. (EIA-364-28 Condition I)
Shock (Mechanical)	1 μs Max.	Subject mated connectors to 50 G's (peak value) half-sine shock pulses of 11 milliseconds duration. Three shocks in each direction shall be applied along the three mutually perpendicular axes of the test specimen (18 shocks). The electrical load condition shall be 100mA maximum for all contacts. (EIA-364-27, test condition A)

	ENVIRONMENTAL								
Item	Requirement	Standard							
Resistance to <b>Reflow</b> Soldering Heat	See Product Qualification and Test (Lead Free)	Pre Heat : 150°C ~180°C, 60~120sec. Heat : 230°C Min., 40sec Min. Peak Temp. : 260°C Max, 10sec Max.							
Thermal Shock	See Product Qualification and Test Sequence Group 4	Mated Connector to follow condition for 5 cycles. 1 cycles: -40 +0/-3 °C, 30 minutes +85 +3/-0 °C, 30 minutes (EIA-364-32, test condition I)							
Humidity	See Product Qualification and Test Sequence Group 4	Mated Connector 40°C, 90~95% RH, 120 hours. (EIA-364-31,Condition A, Method II)							



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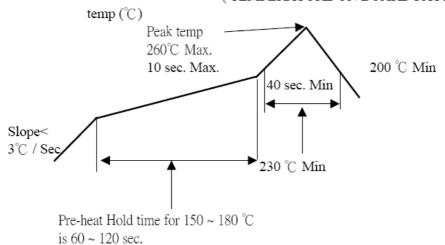
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Temperature life	See Product Qualification and Test Sequence Group 5	Mated connectors to temperature life at 85°C for 96 hours. (EIA-364-17, Test condition A)
Salt Spray (Only For Gold Plating)	See Product Qualification and Test Sequence Group 6	Mated connectors to 5% salt-solution concentration, 35°C (I) Gold flash for 8 hours (II) Gold plating 3 u" for 48 hours (III) Gold plating 5 u" for 96 hours. (EIA-364-26)
Solder ability	Tin plating: Solder able area shall have minimum of 95% solder coverage. Gold plating: Solder able area shall have minimum of 75% solder coverage	And then into solder bath, Temperature at 245 $\pm 5^{\circ}$ C, for 4-5 sec. (EIA-364-52)
Hand Soldering Temperature Resistance	Appearance: No damage	T≧350°C, 3sec at least.

#### 6 INFRARED REFLOW CONDITION

### 6.1. RECOMMENDED REFLOW TEMPERATURE CONDITION

TEMPERATURE CONDITION GRAPH (TEMPERATURE ON BOARD PATTERN SIDE )





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## 7 PRODUCT QUALIFICATION AND TEST SEQUENCE

					Test (	Group				
Test or Examination	1	2	3	4	5	6	7	8	9	10
				Т	est Se	quenc	е			
Examination of Product	1,3	1	1	1 . 7	1、6	1 \ 4	1,3		1,3	1,3
Low Level Contact Resistance		2 ` 6	2 ` 5	2 \ 8	2 \ 7	2 ` 5				4
Insulation Resistance				3 . 9	3、8					
Dielectric Withstanding Voltage				4、10	4 · 9					
Temperature rise	2									
Mating / Unmating Forces		3 ` 5								
Durability		4								
Vibration			3							
Shock (Mechanical)			4							
Thermal Shock				5						
Humidity				6						
Temperature life					5					
Salt Spray(Only For Gold Plating)						3				
Solder ability							2			
Terminal / Housing Retention Force (Rcpt. CONN.)								1		
Hand Soldering Temperature Resistance									2	
Resistance to Soldering Heat										2
Sample Size	2	4	4	4	4	4	2	4	4	4